

FIG. 1

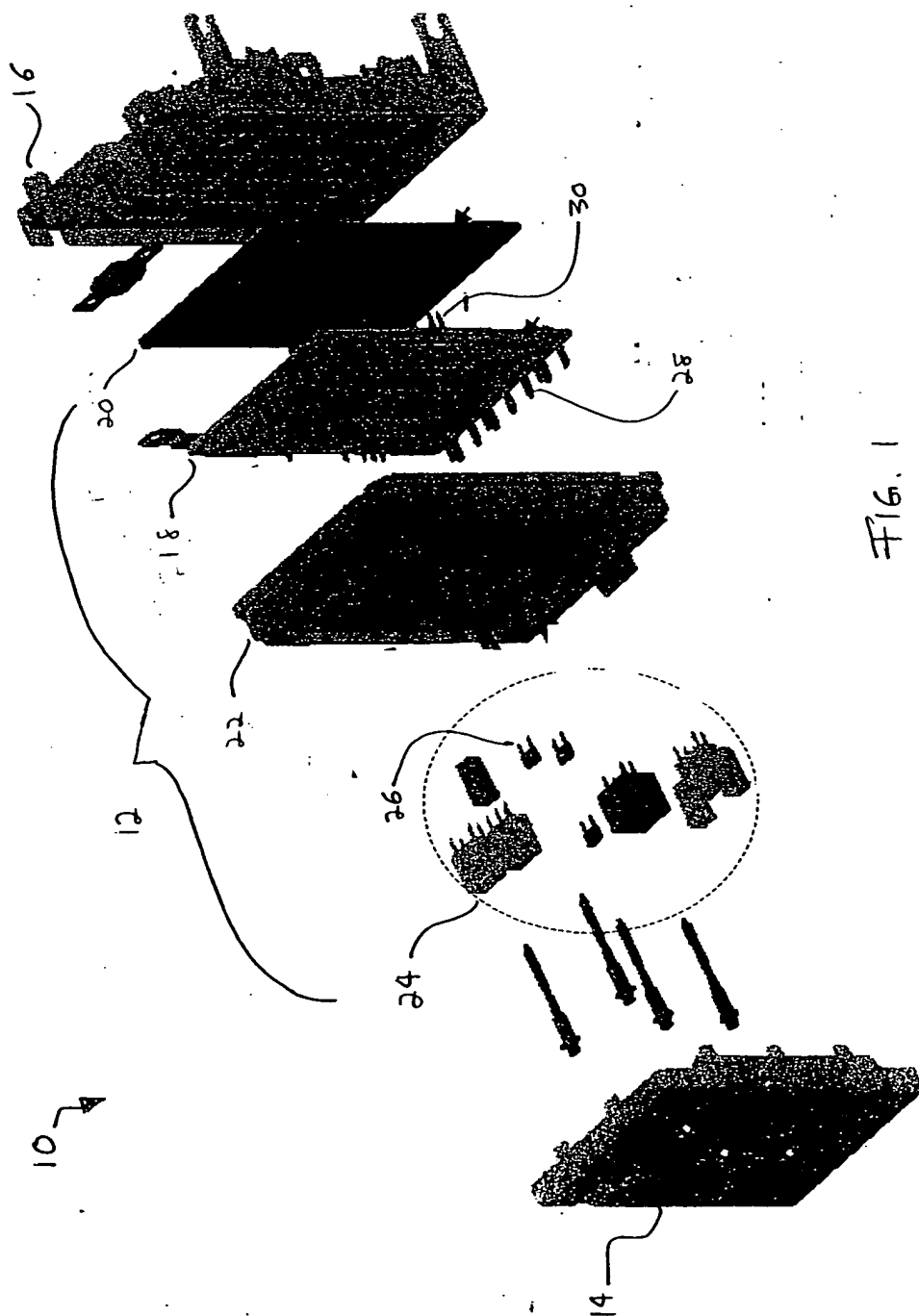


FIG. 1
PRIOR ART

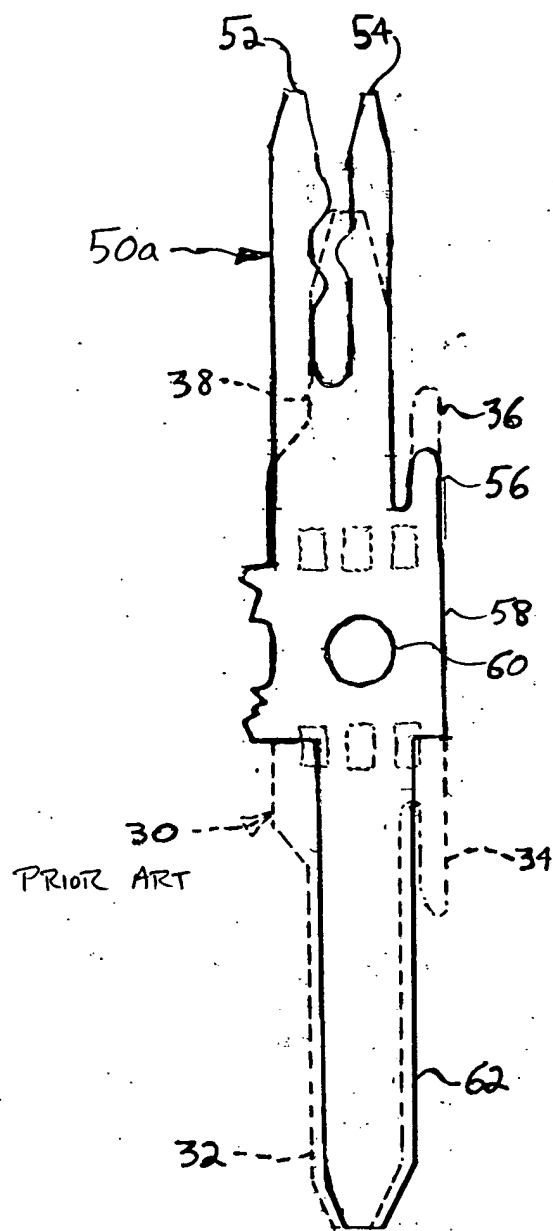


FIG. 2

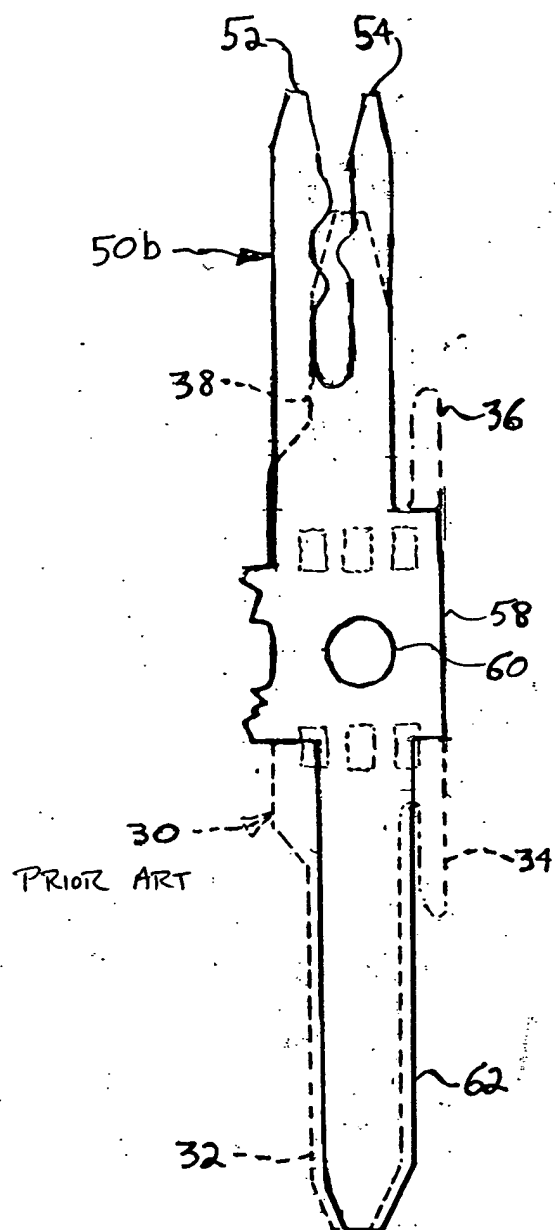


FIG. 3

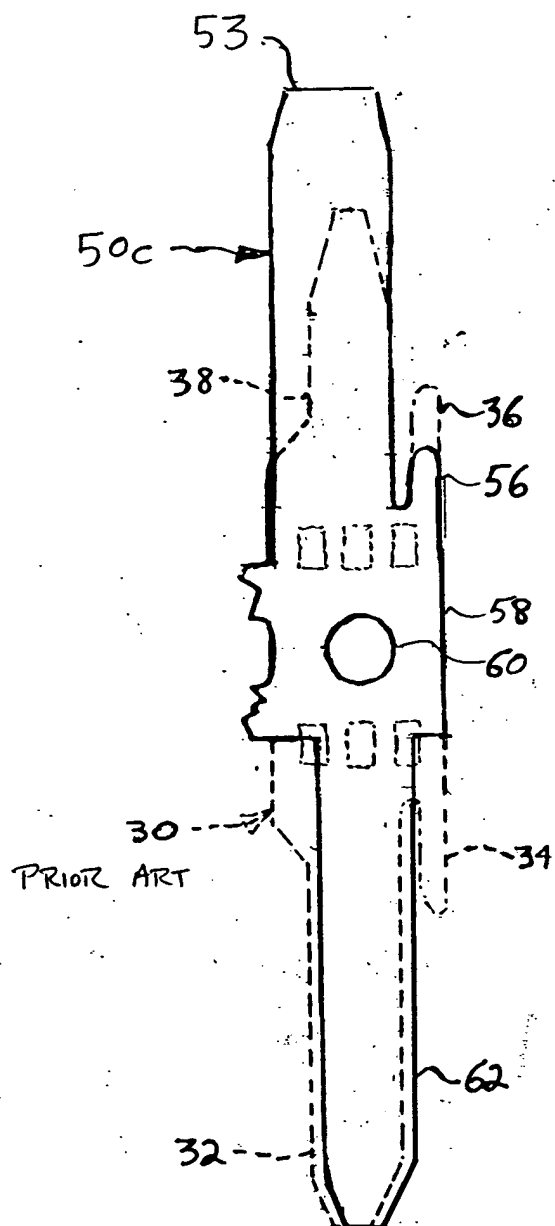


FIG. 4

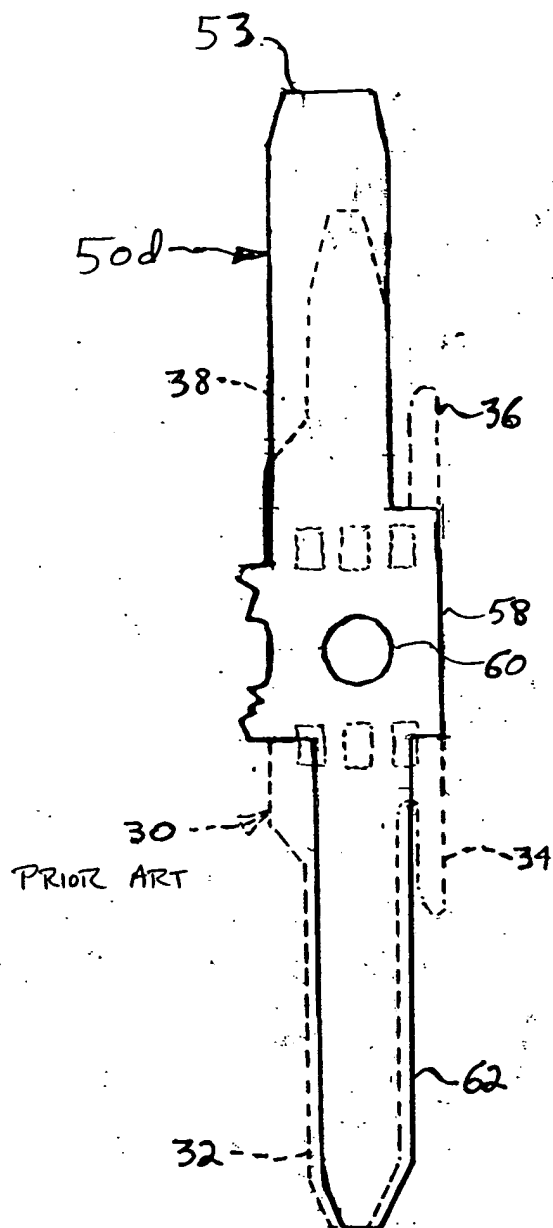
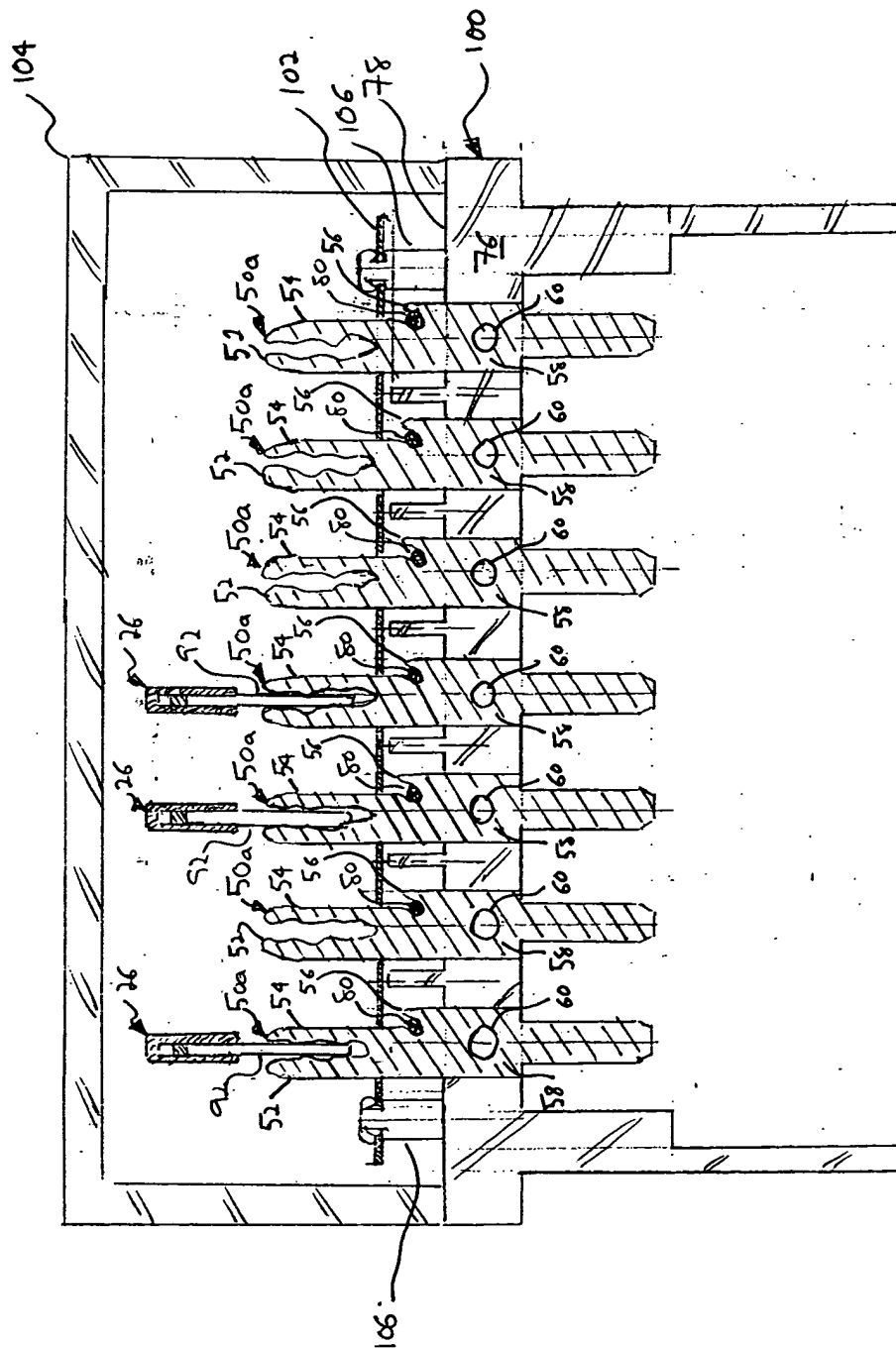


FIG. 5

FIG. 7



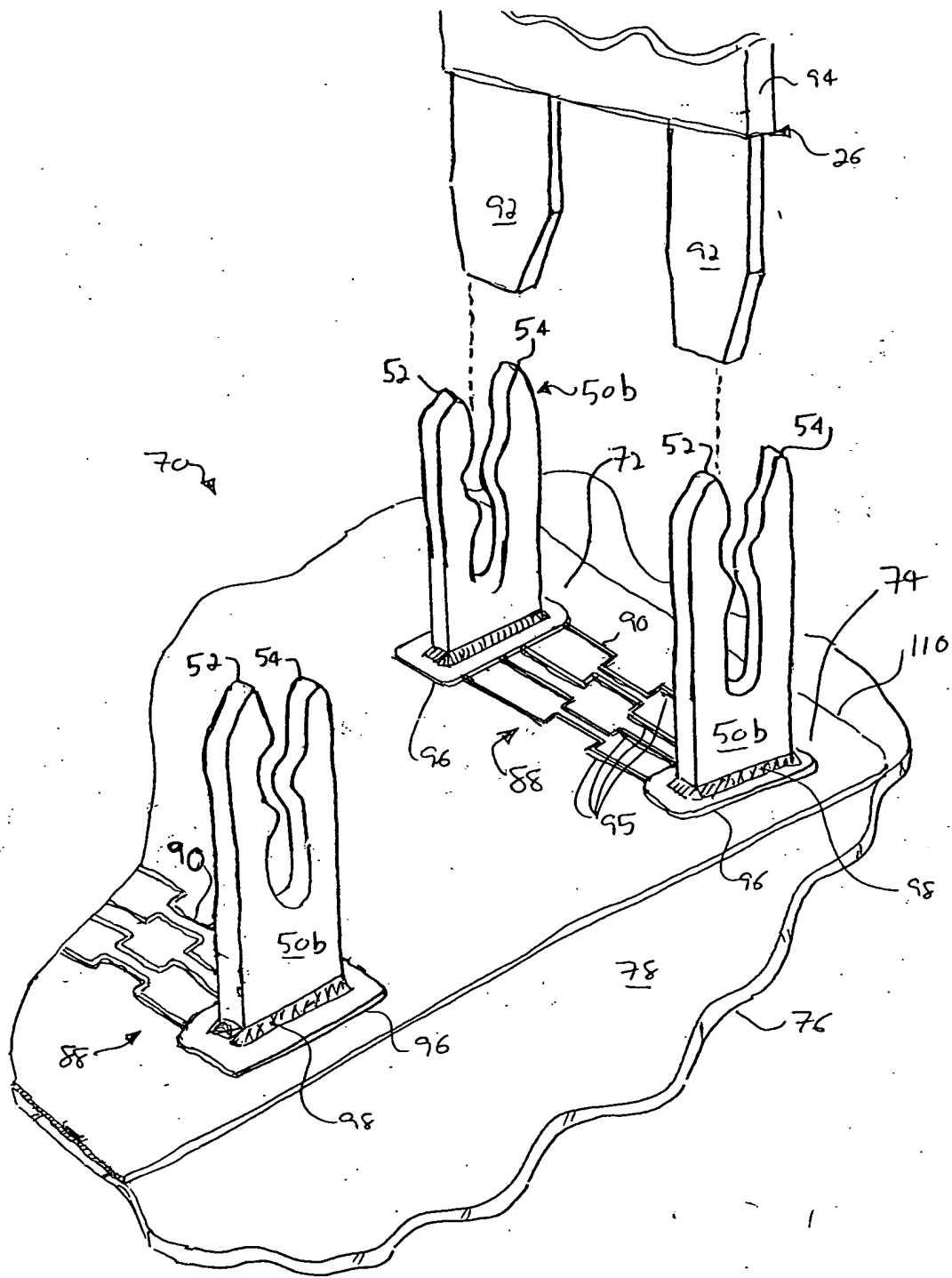


Fig. 9

[illegible]

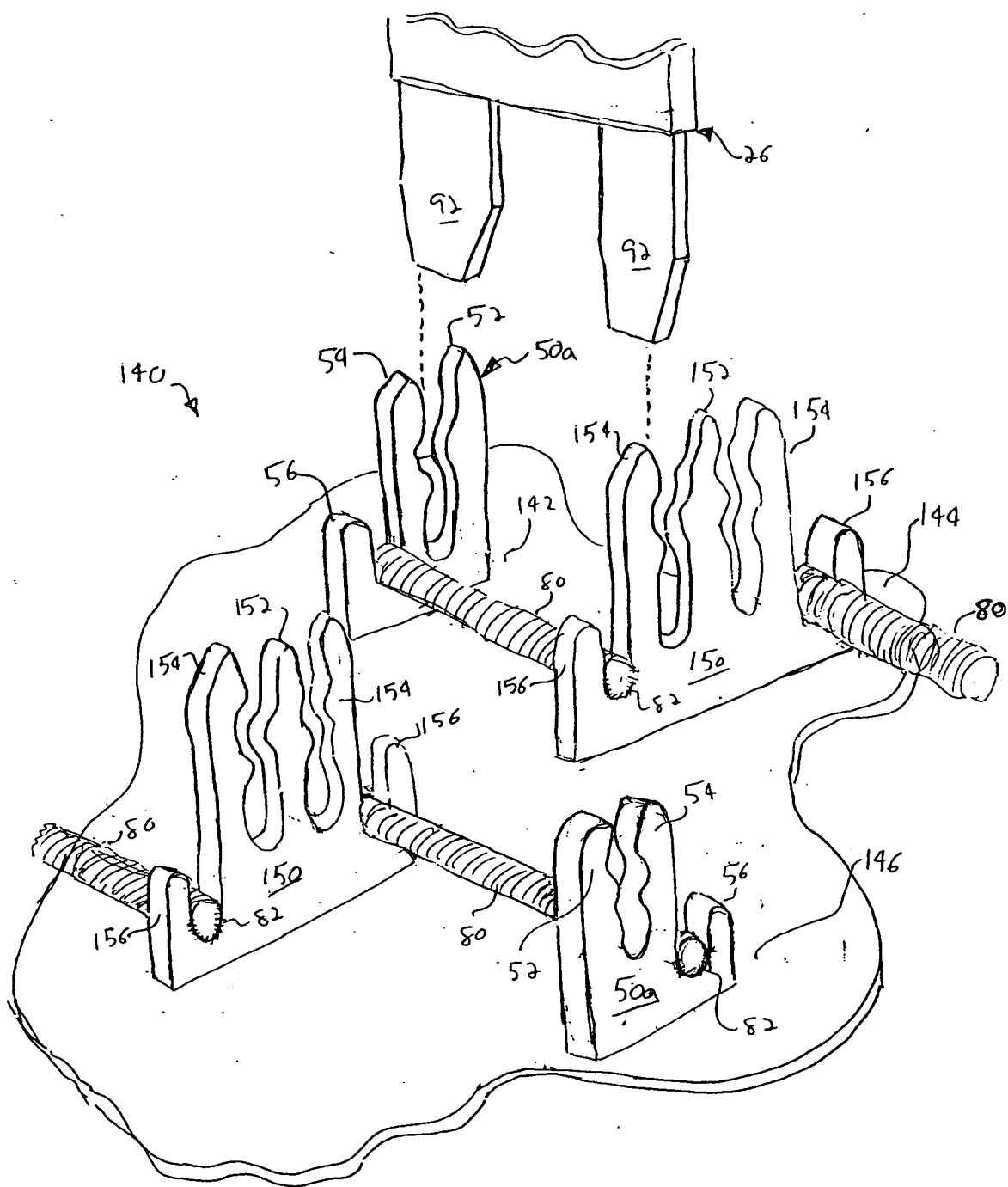


FIG. 11

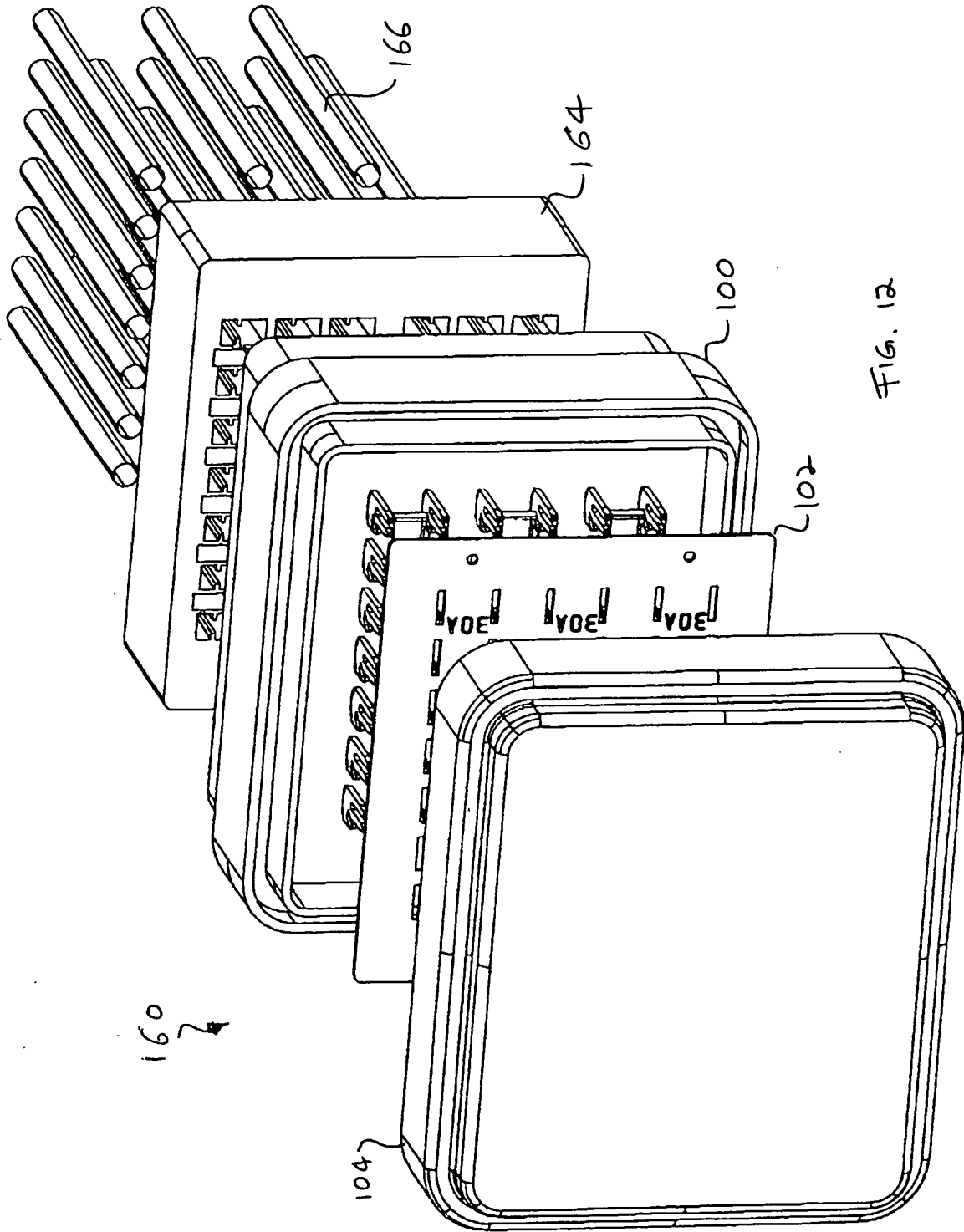


FIG. 13 is a perspective view of the device 100 showing the top surface 101 and the side surface 102. The device 100 includes a plurality of conductive traces 104 and 106, and a plurality of conductive pads 108 and 110. The device 100 is shown in a perspective view, and the top surface 101 and the side surface 102 are indicated by dashed lines. The device 100 is shown in a perspective view, and the top surface 101 and the side surface 102 are indicated by dashed lines.

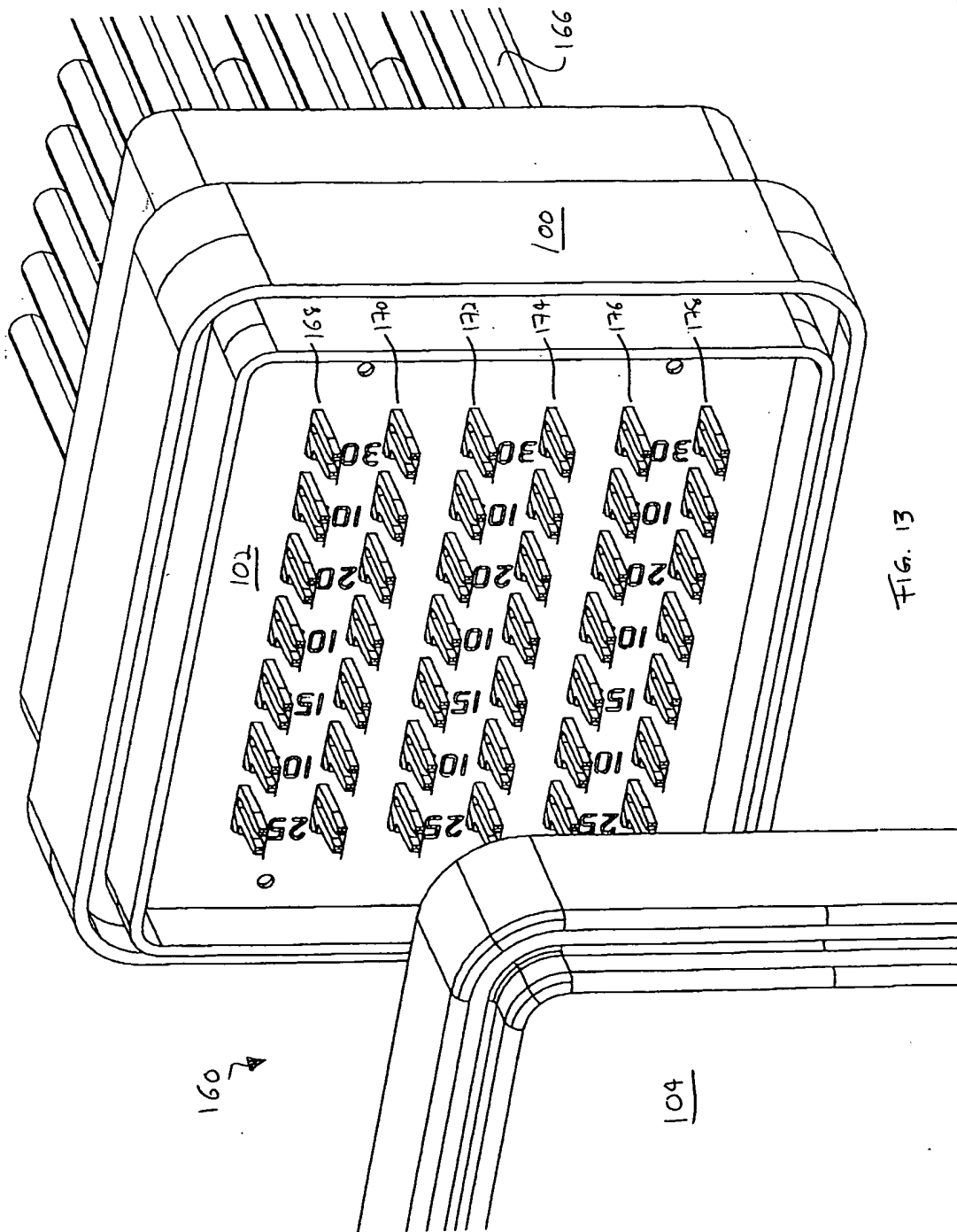


FIG. 13